

Ceramic Resonators (CERALOCK®)



EU RoHS Compliant

- · All the products in this catalog comply with EU RoHS.
 · EU RoHS is "the European Directive 2011/65/EU on the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment."
 · For more details, please refer to our website 'Murata's Approach for EU RoHS'
- (http://www.murata.com/en-eu/support/compliance/rohs).



Contents

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Murata Manufacturing Co., Ltd.

Product specifications are as of March 2015.

CERALOCK®, CERALOCK(R) and "CERALOCK"

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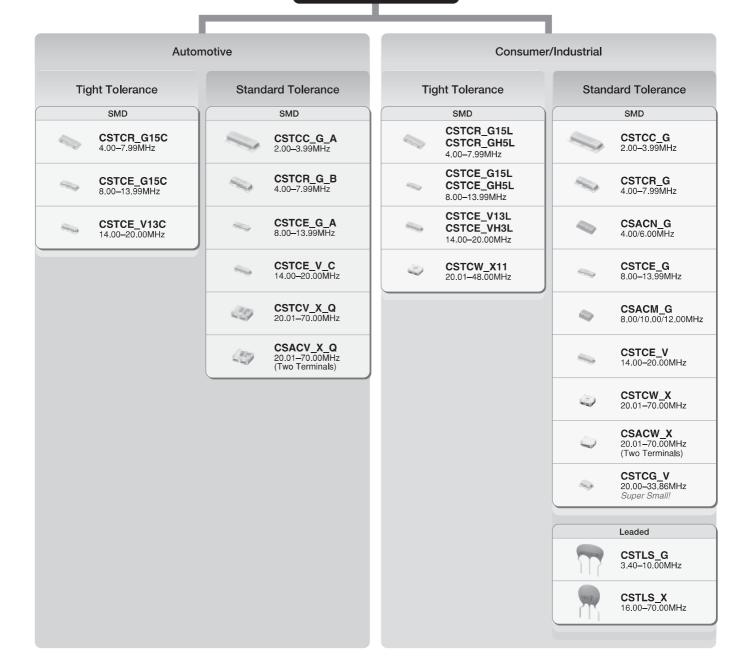
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Please check the MURATA home page (http://www.murata.com/) if you cannot find the part number in the catalog.

Selection Guide

Applications



Notice: "CERALOCK® for consumer" and "CERALOCK® for automotive" is different in the specification of Operating Temperature Range, Environmental Characteristics, Physical Characteristics and so on. Please choose either "for consumer" or "for automotive" according to the required specification.

Part Numbering

CERALOCK® (MHz)

(Part Number) CS T CE 16M0 V 5 3 *** -R0

●Product ID

Product ID	
cs	Ceramic Resonators

2Frequency/Capacitance

Code	Frequency/Capacitance			
Α	MHz with No Capacitance Built-in			
Т	MHz with Built-in Capacitance			

3Structure/Size

Code	Structure/Size			
LS	Round Lead Type			
СС	Cap Chip Type			
CR/CE/CG/CN/CM	Small-cap Chip Type			
CV	Monolithic Chip Type			
CW	Small Monolithic Chip Type			

4 Nominal Center Frequency

Expressed by four-digit alphanumerics. The unit is in hertz (Hz). Decimal point is expressed by capital letter "M."

6Design

Code	Design	
G	Thickness Shear mode	
T/V	Thickness Expander mode	
Х	Thickness Expander mode (3rd overtone)	

6 Initial Frequency Tolerance

Code	Initial Frequency Tolerance			
5	±0.5%			
3	±0.3%			
2	±0.2%			
1	±0.1%			
Н	±0.07%			

Load Capacity

Code	Load Capacity
1	5/6pF
2	10pF
3	15pF
4	22pF
5	30/33/39pF
6	47pF

8 Individual Specification

Code	Individual Specification		
***	Three-digit alphanumerics express "Individual Specification."		

With standard products, "Individual Specification" and "OPackaging" is omitted.

Packaging

Code	Packaging	
-B0	Bulk	
-A0	Radial Taping H ₀ =18mm	
-R0/*R0	Plastic Taping ø=180mm Reel	
-R1	Plastic Taping ø=330mm Reel	

- Radial taping is applied to lead type and plastic taping to chip type.
- In case of CSACN and CSACM series, the hyphen "-" is replaced to a figure which means frequency rank. This figure zero "0" signifies standard part number.

Ceramic Resonators (CERALOCK®)

MHz Chip Type -Tight Frequency Tolerance for Automotive-

Chip type CERALOCK(R) with built-in load capacitors provides high accuracy in an extremely small package. MURATA's frequency adjustment and package technology expertise has enabled the development of the chip CERALOCK(R) with built-in load capacitors.

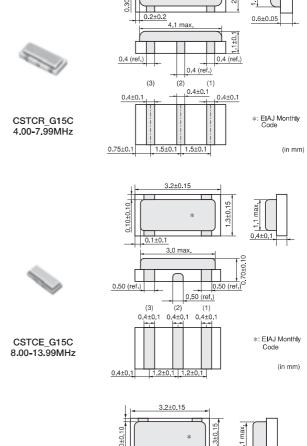
This diverse series owes its development to MURATA's original mass production techniques and high reliability, and has achieved importance in the worldwide automotive market.

■ Features

- 1. The series are high accuracy resonators whose total tolerance is available for less than ±3,000ppm.
- 2. The series has high reliability and is available for a wide temperature range.
- 3. Oscillation circuits do not require external load capacitors.
- 4. The series is available for a wide frequency range.
- 5. The resonators are extremely small and have a low profile.
- 6. No adjustment is necessary for oscillation circuits.

Applications

- 1. Cluster panel and Control panel
- 2. Safety control
 (Anti-lock Brake System, Electronic Stability
 Control, Airbag, etc.)
- 3. Engine ECU, Electronic Power Steering, Immobilizer, etc.
- 4. Car Air conditioner, Power Window, Remote Keyless Entry system, etc.
- 5. Intelligent Transportation System
 (Lane Keeping System, Millimeter wave radar, etc.)
- 6. Battery control for hybrid cars



0.5 (ref.)

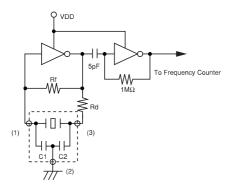
*: EIAJ Monthly

Part Number	Frequency (MHz)	Initial Tolerance	Frequency Shift by Temperature (%)	Operating Temperature Range (°C)
CSTCR_G15C	4.00 to 7.99	±0.1%	±0.13	-40 to 125
CSTCE_G15C	8.00 to 13.99	±0.1%	±0.13	-40 to 125
CSTCE_V13C	14.00 to 20.00	±0.1%	±0.13	-40 to 125

CSTCE_V13C 14.00-20.00MHz

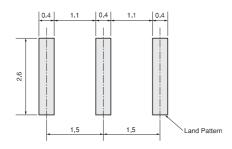
Irregular or stopped oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.

■ Oscillation Frequency Measuring Circuit

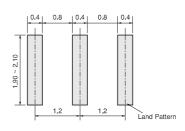


■ Standard Land Pattern Dimensions

CSTCR_G15C (* This Land Pattern is not common to CSTCR_G.)

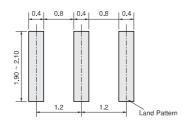


CSTCE_G15C



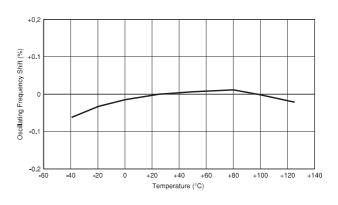
(in mm) (in mm)

CSTCE_V13C (* This Land Pattern is not common to CSTCE_V.)

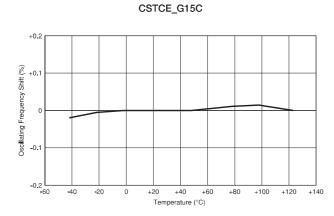


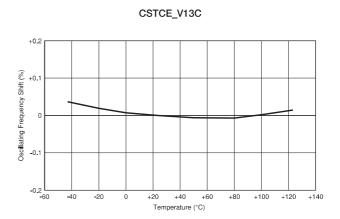
■ Frequency Temperature Characteristics

CSTCR_G15C



(in mm)

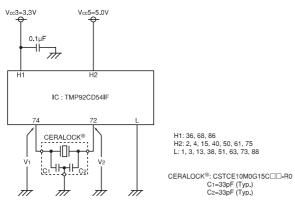




Application Circuits Utilization

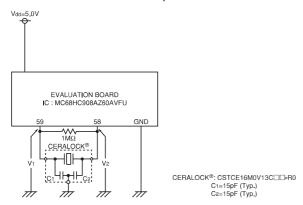
■ TMP92CD54IF (Toshiba)

16-bit Microcomputer



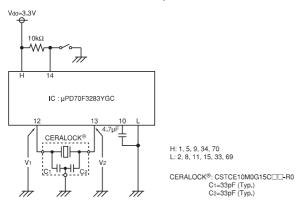
■ MC68HC908AZ60AVFU (Freescale)

8-bit Microcomputer



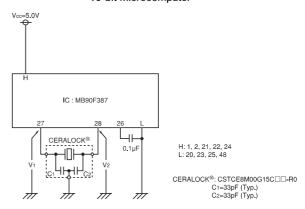
■ µPD70F3283YGC (Renesas)

32-bit Microcomputer



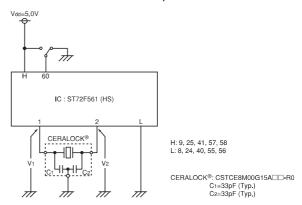
■ MB90F387 (Fujitsu)

16-bit Microcomputer



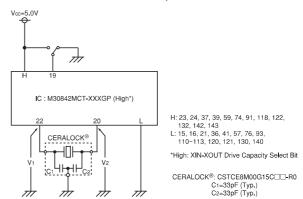
■ ST72F561 (HS) (ST Microelectronics)

8-bit Microcomputer



■ M30842MCT-XXXGP (Renesas)

16-bit Microcomputer



Ceramic Resonators (CERALOCK®)

MHz Chip Type -Standard Frequency Tolerance for Automotive-

Chip type CERALOCK(R) with built-in load capacitors provides high accuracy in an extremely small package. MURATA's frequency adjustment and package technology expertise has enabled the development of the chip CERALOCK(R) with built-in load capacitors.

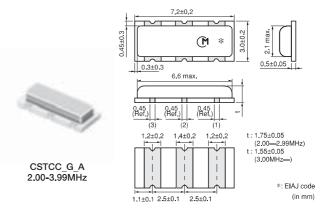
This diverse series owes its development to MURATA's original mass production techniques and high reliability, and has achieved importance in the worldwide automotive market.

■ Features

- 1. The series has high reliability and is available for a wide temperature range.
- 2. Oscillation circuits do not require external load capacitors.
- 3. The series is available in a wide frequency range.
- 4. The resonators are extremely small and have a low
- 5. No adjustment is necessary for oscillation circuits.

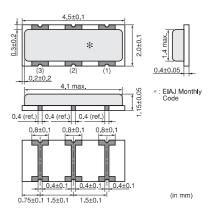
Applications

- 1. Cluster panel and Control panel
- 2. Safety control (Anti-lock Brake System, Electronic Stability Control, Airbag, etc.)
- 3. Engine ECU, Electronic Power Steering, Immobilizer,
- 4. Car Air conditioner, Power Window, Remote Keyless Entry system, etc.
- 5. Electronic Toll Collection system, Car Navigation, etc.



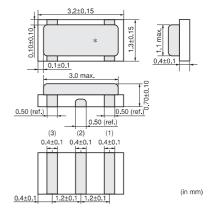


CSTCR_G_B 4.00-7.99MHz



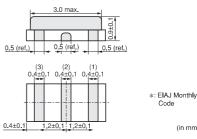


CSTCE_G_A 8.00-13.99MHz





CSTCE_V_C 14.00-20.00MHz

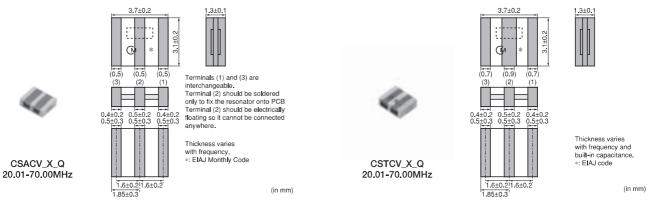


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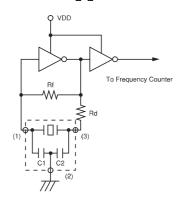


Part Number	Frequency (MHz)	Initial Tolerance	Frequency Shift by Temperature (%)	Operating Temperature Range (°C)
CSTCC_G_A	2.00 to 3.99	±0.5%	±0.4 [-0.6% to +0.3%:Built-in Capacitance 47pF type within Freq.2.00 to 3.49MHz]	-40 to 125
CSTCR_G_B	4.00 to 7.99	±0.5%	±0.15	-40 to 125
CSTCE_G_A	8.00 to 13.99	±0.5%	±0.2	-40 to 125
CSTCE_V_C	14.00 to 20.00	±0.5%	±0.15	-40 to 125
CSACV_X_Q	20.01 to 70.00	±0.5%	±0.3	-40 to 125
CSTCV_X_Q	20.01 to 70.00	±0.5%	±0.3	-40 to 125

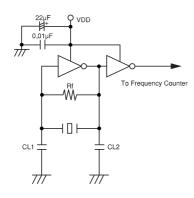
Irregular or stopped oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.

■ Oscillation Frequency Measuring Circuit

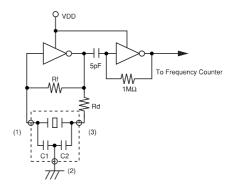
CSTCC_G_A



CSACV_X_Q



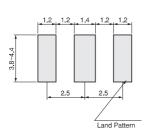
${\tt CSTCE_G_A/CSTCE_V_C/CSTCR_G_B/CSTCV_X_Q}$



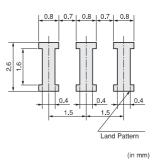
(in mm)

■ Standard Land Pattern Dimensions

CSTCC_G_A



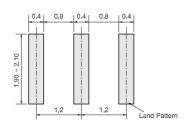
CSTCR_G_B



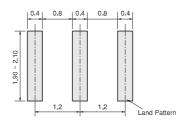
(in mm)

(in mm)

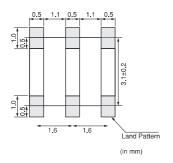
CSTCE_G_A



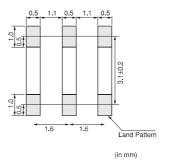
CSTCE_V_C (* This Land Pattern is not common to CSTCE_V.)



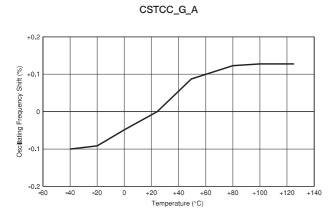
CSTCV_X_Q

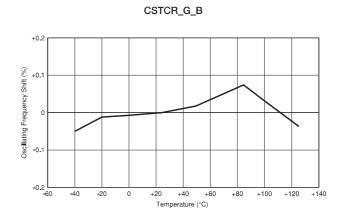


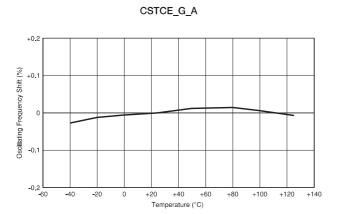
CSACV_X_Q

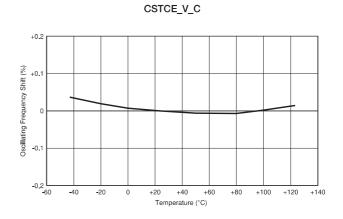


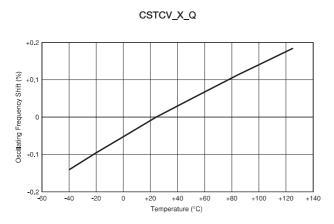
■ Frequency Temperature Characteristics

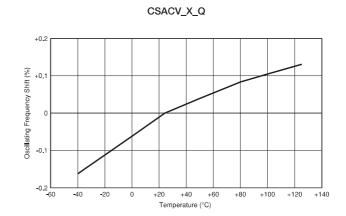








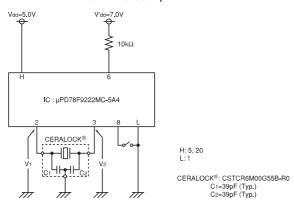




Application Circuits Utilization

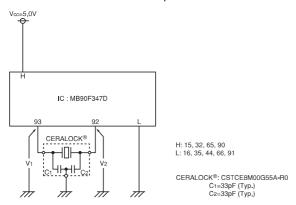
■ µPD78F9222MC-5A4 (Renesas)

8-bit Microcomputer



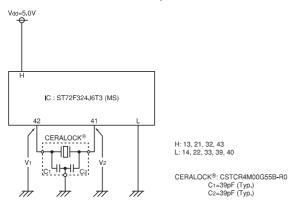
■ MB90F347D (Fujitsu)

16-bit Microcomputer



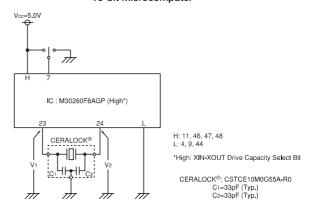
■ ST72F324J6T3 (MS) (ST Microelectronics)

8-bit Microcomputer



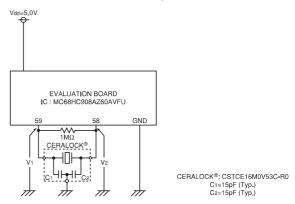
■ M30260F8AGP (Renesas)

16-bit Microcomputer



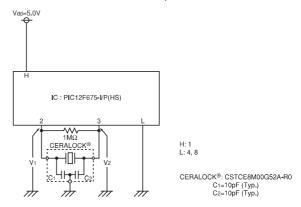
■ MC68HC908AZ60AVFU (Freescale)

8-bit Microcomputer



■ PIC12F675-I/P (HS) (Microchip)

8-bit Microcomputer



■ Soldering and Mounting (CSTCC/CSTCR/CSTCE_V/CSTCE_G Series)

1. Soldering

(1) Reflow soldering

Please mount component on a circuit board by reflow soldering. Flow soldering is not acceptable.

Recommendable Flux and Solder

Flux	Please use rosin based flux, not water soluble flux.
Solder	Please use solder (Sn-3.0Ag-0.5Cu) under the following conditions: Standard thickness of soldering paste: 0.10 to 0.15mm.

Recommendable Soldering Profile

Pre-heating	150 to 180°C	60 to 120s
Heating	220°C min.	30 to 60s
Dools Townsoreture	upper limit: 260°C	1s max.
Peak Temperature	lower limit: 245°C	5s max.

Temperature shall be measured on the surface of component.



If compelled to mount the component by using soldering iron, please do not directly touch the component with the soldering iron. The component terminals or electrical characteristics may be damaged if excessive thermal stress is applied.

Recommendable Soldering with Iron

Heating of the soldering iron	350°C max.	
Watt	30W max.	
Shape of the soldering iron	ø3mm max.	
Soldering Time	5s max. at one terminal	
Solder	Sn-3.0Ag-0.5Cu	

(3) Solder Volume

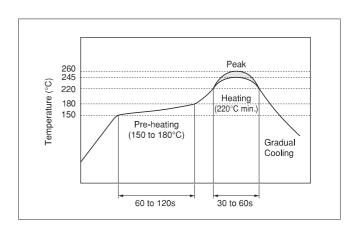
Please make the solder volume less than the height of the substrate to avoid damage to the seal between the metal cap and the substrate.

(4) Other

Do not reuse components removed from a circuit board after soldering.

(5) Conditions for Placement Machines

The component is recommended with placement machines that employ optical placement capabilities. The component may be damaged by excessive mechanical force. Please make sure that you have evaluated by using placement machines before going into mass production. Do not use placement machines that utilize mechanical positioning. Please contact Murata for details beforehand.



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Continued from the preceding page.

2. Wash

(1) Cleaning Solvents

HCFC, Isopropanol, Tap water, Demineralized water, Cleanthrough750H, Pine alpha 100S, Techno care FRW

(2) Temperature Difference : dT *1 dT≦60°C (dT=Component-solvent)

*1 ex. If the component is immersed at +90°C into cleaning solvent at +60°C, then dT=30°C.

(3) Conditions

(a) Ultrasonic Wash

1 minute max. in above solvent at +60°C max. (Frequency: 28kHz, Output: 20W/I)

(4) Drying

5 minutes max. by air blow at +80°C max.

- (5) Other
 - (a) Total washing time should be within 10 minutes.
 - (b) The component may be damaged if it is washed with chlorine, petroleum, or alkali cleaning solvent.

3. Coating

Conformal coating of the component is acceptable. However, the resin material, curing temperature, and other process conditions should be evaluated to confirm stable electrical characteristics are maintained.

- (b) Immersion Wash 5 minutes max. in above solvent at +60°C max.
- (c) Shower or Rinse Wash 5 minutes max. in above solvent at +60°C max.



■ Soldering and Mounting (CSTCV/CSACV Series)

1. Soldering

(1) Reflow soldering

Please mount component on a circuit board by reflow soldering. Flow soldering is not acceptable.

Recommendable Flux and Solder

Flux	Please use rosin based flux, not water soluble flux.
Solder	Please use solder (Sn-3.0Ag-0.5Cu) under the following conditions: Standard thickness of soldering paste: 0.10 to 0.15mm.

Recommendable Soldering Profile

Pre-heating	150 to 180°C	60 to 120s
Heating	220°C min.	30 to 60s
Dook Tompovotuvo	upper limit: 260°C	1s max.
Peak Temperature	lower limit: 245°C	5s max.

Temperature shall be measured on the surface of component.

(2) Soldering with Iron

If compelled to mount the component by using soldering iron, please do not directly touch the component with the soldering iron. The component terminals or electrical characteristics may be damaged if excessive thermal stress is applied.

Recommendable Soldering with Iron

Heating of the soldering iron	350°C max.
Watt	30W max.
Shape of the soldering iron	ø3mm max.
Soldering Time	5s max. at one terminal
Solder	Sn-3.0Ag-0.5Cu

(3) Other

Do not reuse components removed from a circuit board after soldering.

(4) Conditions for Placement Machines

The component is recommended with placement machines that employ optical placement capabilities. The component may be damaged by excessive mechanical force. Please make sure that you have evaluated by using placement machines before going into mass production. Do not use placement machines that utilize mechanical positioning. Please contact Murata for details beforehand.

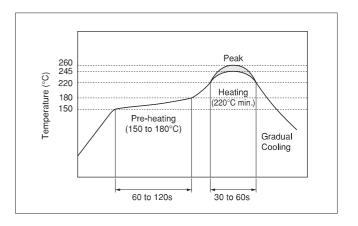
2. Wash

(1) Cleaning Solvents

HCFC, Isopropanol, Tap water, Demineralized water, Cleanthrough750H, Pine alpha 100S, Techno care FRW

(2) Temperature Difference : dT *1 dT≤60°C (dT=Component-solvent)

*1 ex. If the component is immersed at +90°C into cleaning solvent at +60°C, then dT=30°C.



Continued from the preceding page.

(3) Conditions

(a) Ultrasonic Wash

1 minute max. in above solvent at +60°C max. (Frequency: 28kHz, Output: 20W/I)

(4) Drying

5 minutes max. by air blow at $+80^{\circ}$ C max.

- (5) Other
 - (a) Total washing time should be within 10 minutes.
 - (b) The component may be damaged if it is washed with chlorine, petroleum, or alkali cleaning solvent.

3. Coating

Conformal coating of the component is acceptable. However, the resin material, curing temperature, and other process conditions should be evaluated to confirm stable electrical characteristics are maintained.

- (b) Immersion Wash
 - 5 minutes max. in above solvent at +60°C max.
- (c) Shower or Rinse Wash 5 minutes max. in above solvent at +60°C max.



■ Storage and Operating Conditions

1. Product Storage Conditions

Please store the products in a room where the temperature/humidity is stable, and avoid such places where there are large temperature changes. Please store the products under the following conditions:

Temperature: -10 to +40°C Humidity: 15 to 85% R.H.

- 2. Expiration Date on Storage
 - Expiration date (Shelf life) of the products is six months after delivery under the conditions of a sealed and unopened package. Please use the products within six months after delivery. If you store the products for a long time (more than six months), use carefully because the products may be degraded in solderability and/or rusty. Please confirm solderability and characteristics
 - for the products regularly.
- 3. Notice on Product Storage
 - (1) Please do not store the products in a chemical atmosphere (Acids, Alkali, Bases, Organic gas, Sulfides and so on), because the characteristics may be reduced in quality, and/or be degraded in the solderability due to the storage in a chemical atmosphere.
- Rating

The component may be damaged if excessive mechanical stress is applied.

Handling

"CERALOCK" may stop oscillating or oscillate irregularly under improper circuit conditions.

- (2) Please do not put the products directly on the floor without anything under them to avoid damp and/or dusty places.
- (3) Please do not store the products in places such as: in a damp heated place, in a place where direct sunlight comes in, in a place applying vibrations.
- (4) Please use the products immediately after the package is opened, because the characteristics may be reduced in quality, and/or be degraded in the solderability due to storage under the poor conditions.
- (5) Please do not drop the products to avoid cracking of ceramic elements.
- 4. Other

Conformal coating of the component is acceptable. However, the resin material, curing temperature, and other process conditions should be evaluated to confirm that stable electrical characteristics are maintained.

Please be sure to consult with our sales representatives or engineers whenever and prior to using the products.



Packaging for Automotive

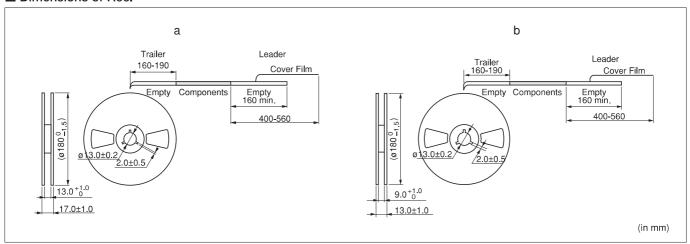
■ Minimum Quantity

Part Number	Plastic Tape ø180mm	Plastic Tape ø330mm	Bulk	Reel Dimensions
CSTCC_G_A	2,000	6,000	500	a
CSTCR_G_B	3,000	9,000	500	а
CSTCR_G15C	3,000	9,000	500	а
CSTCE_G_A	3,000	9,000	500	b
CSTCE_G15C	3,000	9,000	500	b
CSTCE_V_C	3,000	9,000	500	b
CSTCE_V13C	3,000	9,000	500	b
CSTCV_X_Q	2,000	6,000	500	а
CSACV_X_Q	2,000	6,000	500	а

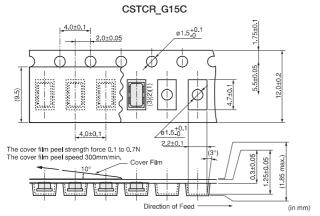
The order quantity should be an integral multiple of the "Minimum Quantity" shown above.

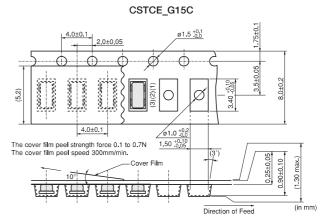
(pcs.)

■ Dimensions of Reel



■ Dimensions of Taping





Continued on the following page.

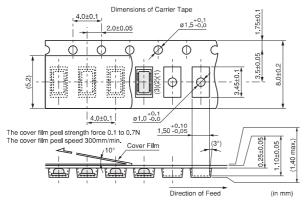


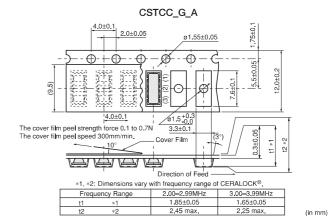
Packaging for Automotive

Continued from the preceding page.

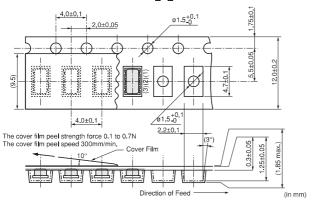
■ Dimensions of Taping

CSTCE_V13C

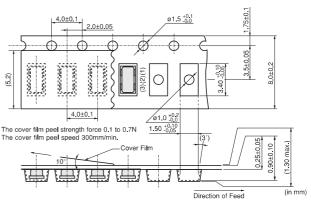




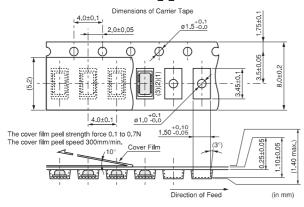
CSTCR_G_B



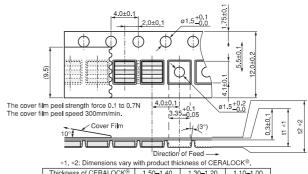
CSTCE_G_A



CSTCE_V_C



CSTCV_X_Q



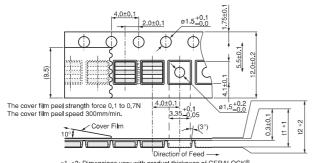
*1, *2: Uninensions vary with product thickness of CEHALOUK*.

Thickness of CERALOCK* 1.50-1.40 1.30-1.20 1.10-1.00

11 *1 1.65±0.1 1.45±0.1 1.2±0.1

12 *2 2.0 max. 1.8 max. 1.5 max. (in mm)

CSACV_X_Q



*1, *2: Dimensions vary with product thickness of CERALOCK®.

Thickness of CERALOCK® 1.50–1.40 1.30–1.20 1.10–1.00 11 *1 1.65±0.1 1.45±0.1 1.2±0.1 1.2±0.1 12 *2 2.0 max. 1.8 max. 1.5 max. (in mm

Ceramic Resonators (CERALOCK®)

MHz Chip Type -Tight Frequency Tolerance for Consumer/Industrial Usage-

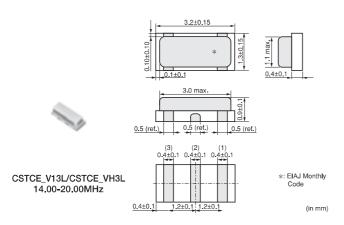
Chip type CERALOCK(R) with built-in load capacitors provides high accuracy in an extremely small package. MURATA's frequency adjustment and packaging technology expertise has enabled the development of the chip CERALOCK(R) with built-in load capacitors. High-density mounting is made possible by the small package and the elimination of the need for an external load capacitor.

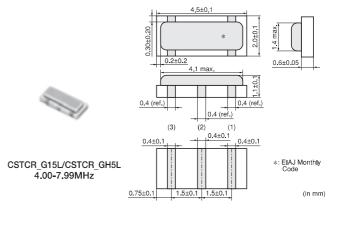
■ Features

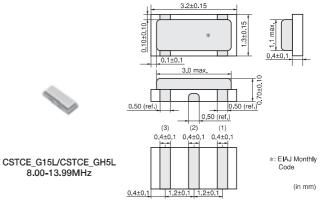
- Oscillation circuits do not require external load capacitors.
- 2. Available in a wide frequency range.
- 3. Extremely small and have a low profile.
- 4. No adjustment is necessary for oscillation circuits.

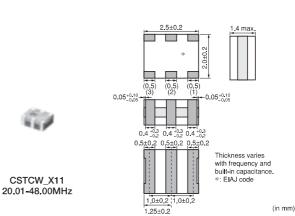
Applications

- Clock oscillators for USB (Full-speed) controller ICs
- 2. Audio equipment and musical instruments, etc.
- Other applications for replacement of Crystal units/ Oscillators







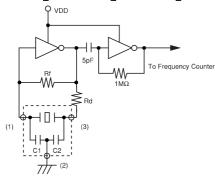


Part Number	Frequency (MHz)	Initial Tolerance	Frequency Shift by Temperature (%)	Operating Temperature Range (°C)
CSTCR_G15L	4.00 to 7.99	±0.1%	±0.08	0 to 70
CSTCR_GH5L	4.00 to 7.99	±0.07%	±0.08	0 to 70
CSTCE_G15L	8.00 to 13.99	±0.1%	±0.08	0 to 70
CSTCE_GH5L	8.00 to 13.99	±0.07%	±0.08	0 to 70
CSTCE_V13L	14.00 to 20.00	±0.1%	±0.08	0 to 70
CSTCE_VH3L	14.00 to 20.00	±0.07%	±0.08	0 to 70
CSTCW_X11	20.01 to 48.00	±0.1%	±0.1	0 to 70

Irregular or stopped oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.

■ Oscillation Frequency Measuring Circuit

CSTCR_G15L/CSTCR_GH5L/CSTCE_G15L/ CSTCE_GH5L/CSTCE_V13L/CSTCE_VH3L

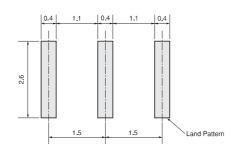


To Frequency Counter

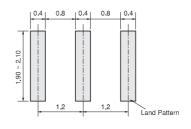
CSTCW_X11

■ Standard Land Pattern Dimensions

CSTCR_G15L/CSTCR_GH5L (* This Land Pattern is not common to CSTCR_G.)



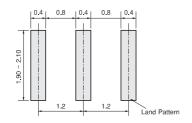
CSTCE_G15L/CSTCE_GH5L



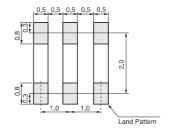
(in mm)

(in mm)

CSTCE_V13L/CSTCE_VH3L (* This Land Pattern is not common to CSTCE_V.)



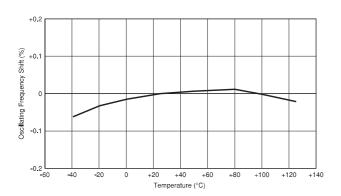
CSTCW_X11



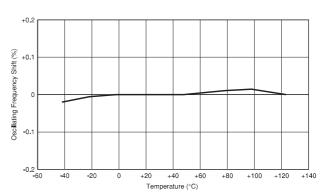
(in mm)

(in mm)

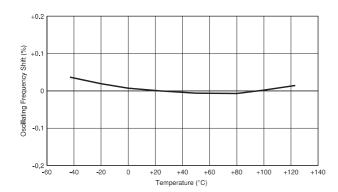
■ Frequency Temperature Characteristics CSTCR_G15L/CSTCR_GH5L



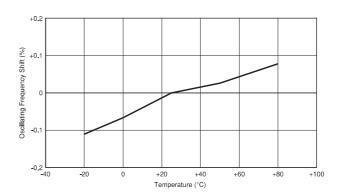
CSTCE_G15L/CSTCE_GH5L



CSTCE_V13L/CSTCE_VH3L



CSTCW_X11

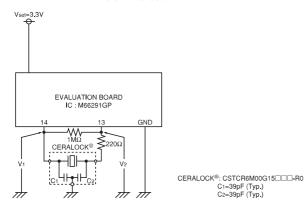


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Application Circuits Utilization

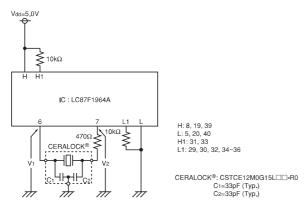
■ M66291GP (Renesas)

USB Transceiver



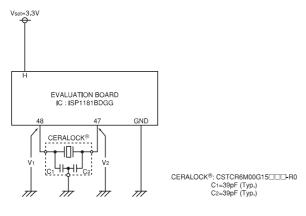
■ LC87F1964A (Sanyo)

8-bit Microcontroller



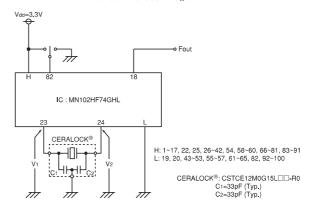
■ ISP1181BDGG (Philips)

USB Controller



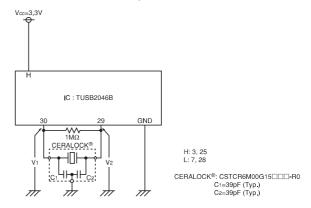
■ MN102HF74GHL (Panasonic)

16-bit Microcontroller



■ TUSB2046B (Texas Instruments)

USB 4-port HUB



Ceramic Resonators (CERALOCK®)

MHz Chip Type -Standard Frequency Tolerance for Consumer/Industrial Usage-

Chip type CERALOCK(R) with built-in load capacitors provides an extremely small package.

MURATA's package technology expertise has enabled the development of the Chip CERALOCK(R) with built-in load capacitors.

High-density mounting can be realized because of the small package and the elimination of the need for an external load capacitor.

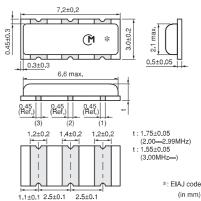
Features

- 1. Oscillation circuits do not require external load capacitors.
- 2. Available in a wide frequency range.
- 3. Extremely small and have a low profile.
- 4. No adjustment is necessary for oscillation circuits.

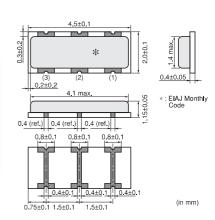
Applications

- 1. Clock oscillators for microprocessors
- 2. Small electronic equipment such as handheld phone, digital video camcorder (DVC), digital still camera (DSC), portable audio player, etc.
- 3. Storage media and memory (HDD, Optical storage device, FDD, Flash memory card, etc.)
- 4. Office automation equipment (Mobile PC, Mouse, Keyboard, etc.)
- 5. Audio-visual applications (TV, DVD-HDD recorder, Audio equipment, Remote control, etc.)
- 6. Home appliances (Air conditioner, Microwave oven, Refrigerator, Washing machine, etc.)



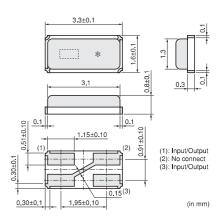


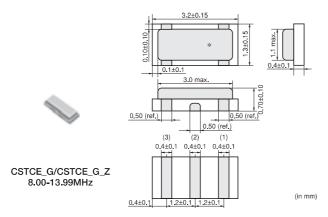




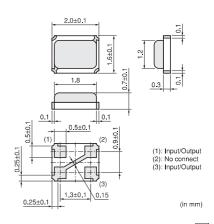


4.00/6.00MHz



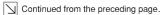


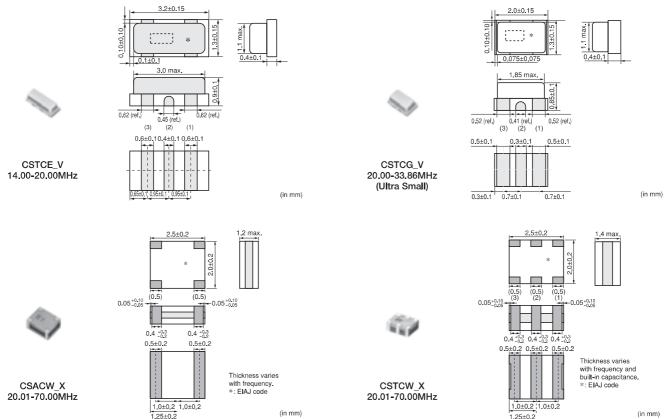




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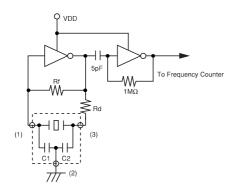


Part Number	Frequency (MHz)	Initial Tolerance	Frequency Shift by Temperature (%)	Operating Temperature Range (°C)
CSTCC_G	2.00 to 3.99	±0.5%	±0.3 [±0.4%:Built-in Capacitance 47pF type within Freq.2.00 to 3.49MHz]	-20 to 80
CSTCR_G	4.00 to 7.99	±0.5%	±0.2	-20 to 80
CSACN_G*	4.00, 6.00	±0.5%	-0.25 to +0.2	-20 to 85
CSTCE_G	8.00 to 13.99	±0.5%	±0.2	-20 to 80
CSTCE_G_Z	8.00 to 13.99	±0.5%	±0.2	-40 to 125
CSACM_G*	8.00, 10.00, 12.00	±0.5%	-0.25 to +0.2	-20 to 85
CSTCE_V	14.00 to 20.00	±0.5%	±0,3	-20 to 80
CSTCG_V	20.00 to 33.86	±0.5%	±0.3	-20 to 80
CSACW_X	20.01 to 70.00	±0.5%	±0.2	-20 to 80
CSTCW_X	20.01 to 70.00	±0.5%	±0.2	-20 to 80

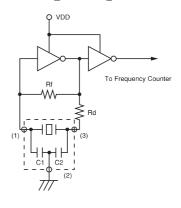
Irregular or stopped oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.

■ Oscillation Frequency Measuring Circuit

CSTCR_G/CSTCE_G/CSTCE_G_Z/CSTCE_V/CSTCG_V



CSTCC_G/CSTCW_X



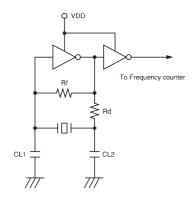
Continued on the following page.



^{*:} Please refer to Notice.

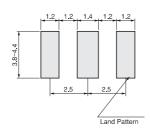
■ Oscillation Frequency Measuring Circuit

CSACN_G/CSACM_G/CSACW_X



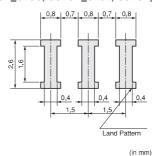
■ Standard Land Pattern Dimensions

CSTCC_G

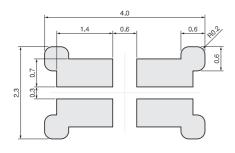


(in mm)

CSTCR_G (* This Land Pattern is not common to CSTCR_G15C, CSTCR_G15L, CSTCR_GH5L.)

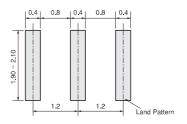


CSACN_G



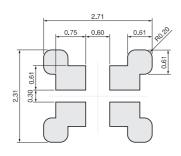
(in mm)

CSTCE_G/CSTCE_G_Z

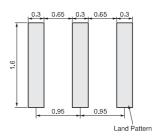


(in mm)

CSACM_G



CSTCE_V (* This Land Pattern is not common to CSTCE_V13C, CSTCE_V_C, CSTCE_V13L, CSTCE_VH3L.)



(in mm)

Continued on the following page.



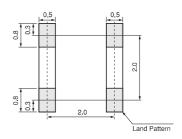
(in mm)

■ Standard Land Pattern Dimensions

CSTCG_V

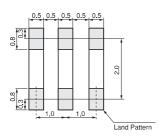
1.6

CSACW_X



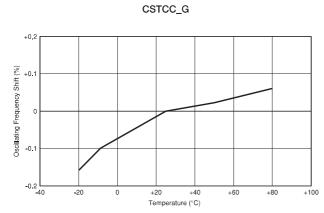
(in mm)

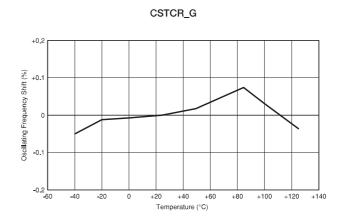
CSTCW_X

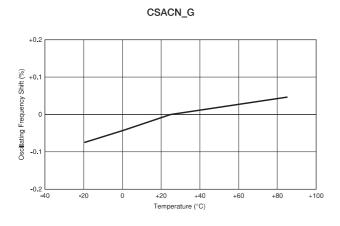


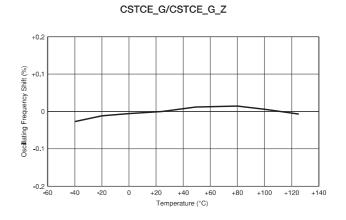
(in mm)

■ Frequency Temperature Characteristics



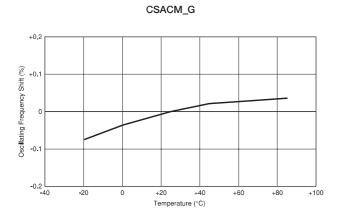


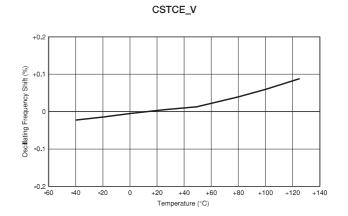


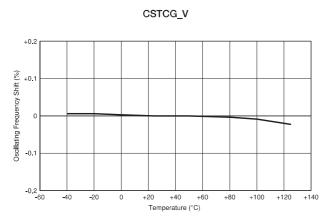


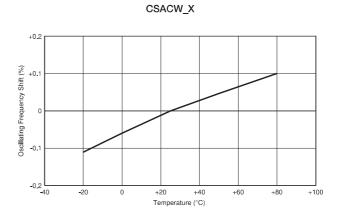
Continued on the following page.

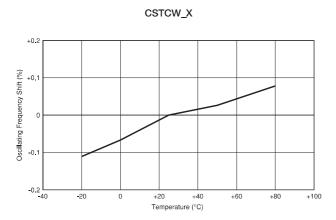
■ Frequency Temperature Characteristics







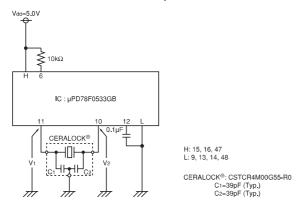




Application Circuits Utilization

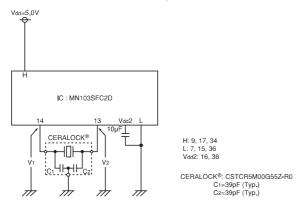
■ µPD78F0533GB (Renesas)

8-bit Microcomputer



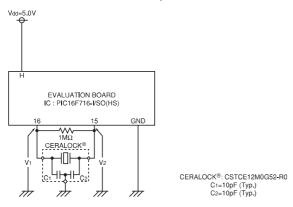
■ MN103SFC2D (Panasonic)

32-bit Microcomputer



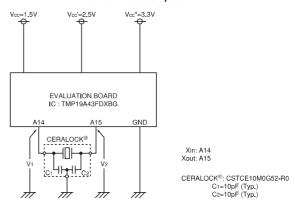
■ PIC16F716-I/SO (Microchip)

8-bit Microcomputer



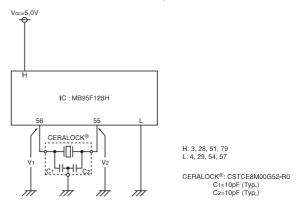
■ TMP19A43FDXBG (Toshiba)

32-bit Microcomputer



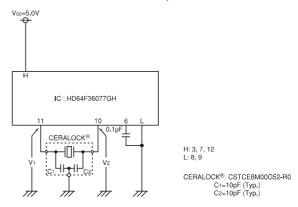
■ MB95F128H (Fujitsu)

8-bit Microcomputer



■ HD64F36077GH (Renesas)

16-bit Microcomputer



Continued on the following page.

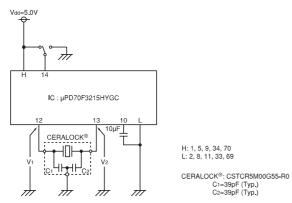


Application Circuits Utilization

Ontinued from the preceding page.

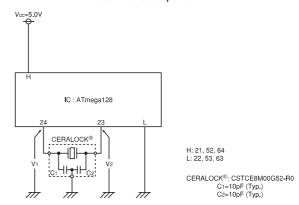
■ µPD70F3215HYGC (Renesas)

32-bit Microcomputer



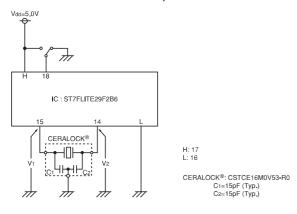
■ ATmega128 (Atmel)

8-bit Microcomputer



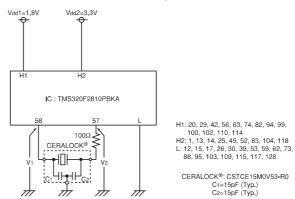
■ ST7FLITE29F2B6 (ST Microelectronics)

8-bit Microcomputer



■ TMS320F2810PBKA (Texas Instruments)

32-bit Microcomputer



Ceramic Resonators (CERALOCK®)

MHz Lead Type -Standard Frequency Tolerance for Consumer/Industrial Usage-

MURATA's ceramic resonator, CERALOCK(R) with built-in load capacitors, has been widely applied as the most suitable component for clock oscillators in a broad range of microprocessors.

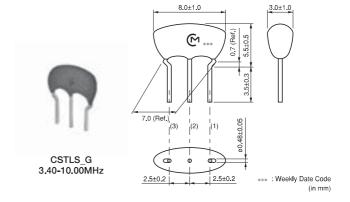
The CSTLS series can be used in the design of oscillation circuits not requiring external load capacitors, enabling both high-density mounting and cost reduction.

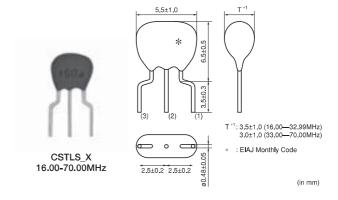
■ Features

- Oscillation circuits do not require external load capacitors.
 - There is some variation in built-in capacitance values applicable to various IC.
- 2. Stable over a wide temperature range.
- 3. Compact, lightweight and exhibit superior shock resistance performance.
- 4. Enable the design of oscillator circuits requiring no adjustment.
- 5. Cost-effective and reliable availability

Applications

- 1. DTMF generators
- 2. Clock oscillators for microcomputers
- 3. Remote control units
- 4. Automated office equipment



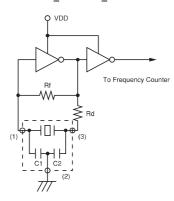


Part Number	Frequency (MHz)	Initial Tolerance	Frequency Shift by Temperature (%)	Operating Temperature Range (°C)
CSTLS_G	3.40 to 10.00	±0.5%	±0.2 [-0.4% to +0.2%:Built-in Capacitance 47pF type]	-20 to 80
CSTLS_X	16.00 to 70.00	±0.5%	±0.2	-20 to 80

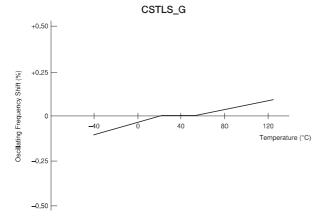
Irregular or stopped oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.

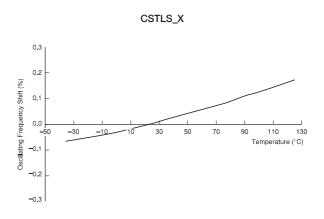
The order quantity should be an integral multiple of the "Minimum Quantity" shown in the packaging page.

■ Oscillation Frequency Measuring Circuit CSTLS_G/CSTLS_X



■ Frequency Temperature Characteristics

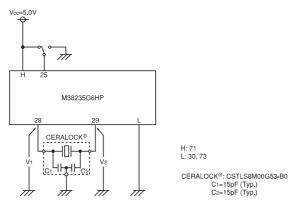




Application Circuits Utilization

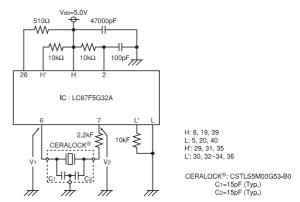
■ M38235G6HP (Renesas)

8-bit Microcomputer



■ LC87F5G32A (Sanyo)

8-bit Microcomputer



■ Soldering and Mounting (CSTCC Series)

1. Soldering

(1) Reflow soldering

Please mount component on a circuit board by reflow soldering. Flow soldering is not acceptable.

Recommendable Flux and Solder

Flux	Please use rosin based flux, not water soluble flux.
Solder	Please use solder (Sn-3.0Ag-0.5Cu) under the following conditions: Standard thickness of soldering paste: 0.10 to 0.15mm.

Recommendable Soldering Profile

Pre-heating	150 to 180°C	60 to 120s
Heating	220°C min.	30 to 60s
Peak Temperature	upper limit: 260°C	1s max.
	lower limit: 245°C	5s max.

Temperature shall be measured on the surface of component.

(2) Soldering with Iron

If compelled to mount the component by using soldering iron, please do not directly touch the component with the soldering iron. The component terminals or electrical characteristics may be damaged if excessive thermal stress is applied.

Recommendable Soldering with Iron

Heating of the soldering iron	350°C max.
Watt	30W max.
Shape of the soldering iron	ø3mm max.
Soldering Time	5s max. at one terminal
Solder	Sn-3.0Ag-0.5Cu

(3) Solder Volume

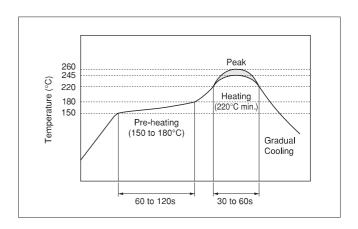
Please make the solder volume less than the height of the substrate to avoid damage to the seal between the metal cap and the substrate.

(4) Other

Do not reuse components removed from a circuit board after soldering.

(5) Conditions for Placement Machines

The component is recommended with placement machines that employ optical placement capabilities. The component may be damaged by excessive mechanical force. Please make sure that you have evaluated by using placement machines before going into mass production. Do not use placement machines that utilize mechanical positioning. Please contact Murata for details beforehand.



Continued on the following page.

Continued from the preceding page.

2. Wash

Some series do not withstand washing. Please check the list at right before use.

(1) Cleaning Solvents

HCFC, Isopropanol, Tap water, Demineralized water, Cleanthrough 750H, Pine alpha 100S, Techno care FRW

(2) Temperature Difference : dT *1 dT≦60°C (dT=Component-solvent)

*1 ex. If the component is immersed at +90°C into cleaning solvent at +60°C, then dT=30°C.

(3) Conditions

(a) Ultrasonic Wash

1 minute max. in above solvent at +60°C max. (Frequency: 28kHz, Output: 20W/I)

(4) Drying

5 minutes max. by air blowing at +80°C max.

(5) Other

- (a) Total washing time should be within 10 minutes.
- (b) The component may be damaged if it is washed with chlorine, petroleum, or alkali cleaning solvent.

3. Coating

Conformal coating of the component is acceptable. However, the resin material, curing temperature, and other process conditions should be evaluated to confirm stable electrical characteristics are maintained.

Wash Series CSTCC (2.00 to 3.49MHz) Not Available CSTCC (3.50 to 3.99MHz) Available

(b) Immersion Wash

5 minutes max. in above solvent at +60°C max.

(c) Shower or Rinse Wash

5 minutes max. in above solvent at +60°C max.

■ Soldering and Mounting (CSTCR/CSTCE_V/CSTCG/CSACN/CSACM/CSTCE_G Series)

1. Soldering

(1) Reflow soldering

Please mount component on a circuit board by reflow soldering. Flow soldering is not acceptable.

Recommendable Flux and Solder

Flux	Please use rosin based flux, not water soluble flux.	
Solder	Please use solder (Sn-3.0Ag-0.5Cu) under the following conditions: Standard thickness of soldering paste: 0.10 to 0.15mm.	

Recommendable Soldering Profile

Pre-heating	150 to 180°C	60 to 120s
Heating	220°C min.	30 to 60s
Daale Tarra anatoma	upper limit: 260°C	1s max.
Peak Temperature	lower limit: 245°C	5s max.

Temperature shall be measured on the surface of component.

(2) Soldering with Iron

If compelled to mount the component by using soldering iron, please do not directly touch the component with the soldering iron. The component terminals or electrical characteristics may be damaged if excessive thermal stress is applied.

Recommendable Soldering with Iron

Heating of the soldering iron	350°C max.
Watt	30W max.
Shape of the soldering iron	ø3mm max.
Soldering Time	5s max. at one terminal
Solder	Sn-3.0Ag-0.5Cu

(3) Solder Volume

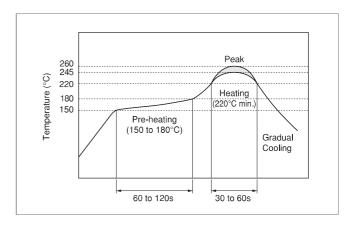
Please make the solder volume less than the height of the substrate to avoid damage to the seal between the metal cap and the substrate.

2. Washing / Coating

Conformal coating or washing of the component is not acceptable, because it is not hermetically sealed. Please contact us if you need a washable component.

3. CSACN/CSACM Series Oscillation Frequency

CSACN/CSACM series is a chip resonator with 2 terminals which does not have built-in load capacitors. Oscillation frequency may vary according to external load capacitance value. Its measurement circuit for standard part number is as shown in Fig.1. Please make sure if oscillation frequency is certainly within a range of frequency tolerance that brings to essential set level performance, when using other value of constant in Fig.1. Please contact us if oscillation frequency needs to be adjusted by a chip resonator itself. There would be some ranked part number that we could propose.

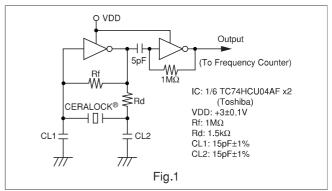


(4) Other

Do not reuse components removed from a circuit board after soldering.

(5) Conditions for Placement Machines

The component is recommended with placement machines that employ optical placement capabilities. The component may be damaged by excessive mechanical force. Please make sure that you have evaluated by using placement machines before going into mass production. Do not use placement machines that utilize mechanical positioning. Please contact Murata for details beforehand.



Continued from the preceding page.

■ Soldering and Mounting (CSACW/CSTCW Series)

1. Soldering

(1) Reflow soldering

Please mount component on a circuit board by reflow soldering. Flow soldering is not acceptable.

Recommendable Flux and Solder

Flux	Please use rosin based flux, not water soluble flux.
Solder	Please use solder (Sn-3.0Ag-0.5Cu) under the following conditions: Standard thickness of soldering paste: 0.10 to 0.15mm.

Recommendable Soldering Profile

Pre-heating	150 to 180°C	60 to 120s
Heating	220°C min.	30 to 60s
Daals Tarran anatoma	upper limit: 260°C	1s max.
Peak Temperature	lower limit: 245°C	5s max.

Temperature shall be measured on the surface of component.



If compelled to mount the component by using soldering iron, please do not directly touch the component with the soldering iron. The component terminals or electrical characteristics may be damaged if excessive thermal stress is applied.

Recommendable Soldering with Iron

Heating of the soldering iron	350°C max.
Watt	30W max.
Shape of the soldering iron	ø3mm max.
Soldering Time	5s max. at one terminal
Solder	Sn-3.0Ag-0.5Cu

(3) Other

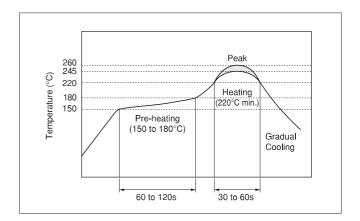
Do not reuse components removed from a circuit board after soldering.

(4) Conditions for Placement Machines

The component is recommended with placement machines that employ optical placement capabilities. The component may be damaged by excessive mechanical force. Please make sure that you have evaluated by using placement machines before going into mass production. Do not use placement machines that utilize mechanical positioning. Please contact Murata for details beforehand.

2. Washing / Coating

Conformal coating or washing of the component is not acceptable, because it is not hermetically sealed. Please contact us if you need a washable component.



■ Storage and Operating Conditions

Product Storage Conditions
 Please store the products in a room where the temperature/humidity is stable, and avoid such places where there are large temperature changes. Please store the products under the following conditions:

Temperature: -10 to +40°C Humidity: 15 to 85% R.H.

- 2. Expiration Date on Storage
 - Expiration date (Shelf life) of the products is six months after delivery under the conditions of a sealed and unopened package. Please use the products within six months after delivery. If you store the products for a long time (more than six months), use carefully because the products may be degraded in solderability and/or rusty. Please confirm solderability and characteristics for the products regularly.
- 3. Notice on Product Storage
 - (1) Please do not store the products in a chemical atmosphere (Acids, Alkali, Bases, Organic gas, Sulfides and so on), because the characteristics may be reduced in quality, and/or be degraded in the solderability due to the storage in a chemical atmosphere.
- Rating

The component may be damaged if excessive mechanical stress is applied.

Handling

"CERALOCK" may stop oscillating or oscillate irregularly under improper circuit conditions.

- (2) Please do not put the products directly on the floor without anything under them to avoid damp and/or dusty places.
- (3) Please do not store the products in places such as: in a damp heated place, in a place where direct sunlight comes in, in a place applying vibrations.
- (4) Please use the products immediately after the package is opened, because the characteristics may be reduced in quality, and/or be degraded in the solderability due to storage under the poor conditions
- (5) Please do not drop the products to avoid cracking of ceramic elements.
- 4. Other

Conformal coating or washing of the component is not acceptable because it is not hermetically sealed.

Please be sure to consult with our sales representatives or engineers whenever and prior to using the products.



■ Soldering and Mounting

The component cannot withstand washing.

Please do not apply excessive mechanical stress to the component and lead terminals during soldering.

Storage and Operating Conditions

Product Storage Conditions
 Please store the products in a room where the temperature/humidity is stable, and avoid such places where there are large temperature changes. Please store the products under the following conditions:

Temperature: -10 to +40°C Humidity: 15 to 85% R.H.

- 2. Expiration Date on Storage
 - Expiration date (Shelf life) of the products is six months after delivery under the conditions of a sealed and unopened package. Please use the products within six months after delivery. If you store the products for a long time (more than six months), use carefully because the products may be degraded in solderability and/or rusty. Please confirm solderability and characteristics for the products regularly.
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The component may be damaged if excessive mechanical stress is applied.

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- (4) Please use the products immediately after the package is opened, because the characteristics may be reduced in quality, and/or be degraded in the solderability due to storage under the poor conditions.
- (5) Please do not drop the products to avoid cracking of ceramic elements.
- 4. Other

Conformal coating or washing of the component is not acceptable because it is not hermetically sealed.

Please be sure to consult with our sales representatives or engineers whenever and prior to using the products.



Packaging for Consumer/Industrial Usage -MHz Chip Type-

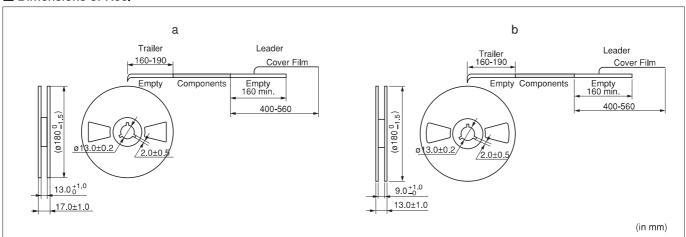
■ Minimum Quantity

Part Number	Plastic Tape ø180mm	Plastic Tape ø330mm	Bu l k	Reel Dimensions
CSTCC_G	2,000	6,000	500	a
CSTCR_G	3,000	9,000	500	a
CSTCR_G15L	3,000	9,000	500	a
CSTCR_GH5L	3,000	9,000	500	а
CSACN_G	3,000	-	-	b
CSTCE_G	3,000	9,000	500	b
CSTCE_G15L	3,000	9,000	500	b
CSTCE_GH5L	3,000	9,000	500	b
CSACM_G	3,000	-	-	b
CSTCE_V	3,000	9,000	500	b
CSTCE_V13L	3,000	9,000	500	b
CSTCE_VH3L	3,000	9,000	500	b
CSTCG_V	3,000	9,000	500	b
CSTCW_X	3,000	9,000	500	b
CSTCW_X11	3,000	9,000	500	b
CSACW_X	3,000	9,000	500	b

The order quantity should be an integral multiple of the "Minimum Quantity" shown above.

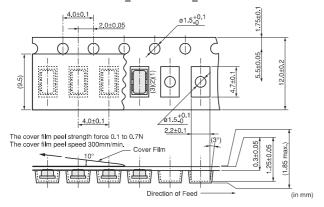
(pcs.)

■ Dimensions of Reel

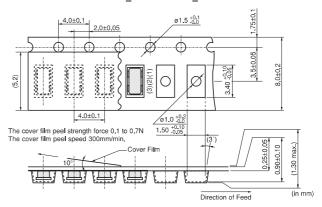


■ Dimensions of Taping

CSTCR_G15L/CSTCR_GH5L



CSTCE_G15L/CSTCE_GH5L

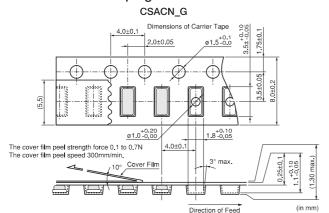


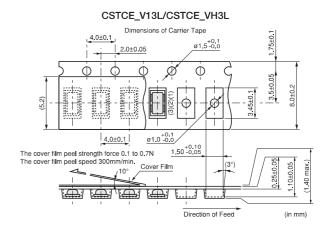
Continued on the following page.

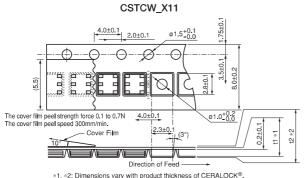
Packaging for Consumer/Industrial Usage -MHz Chip Type-

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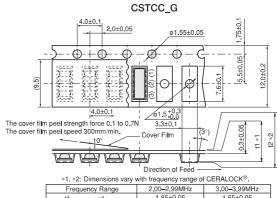
Dimensions of Taping



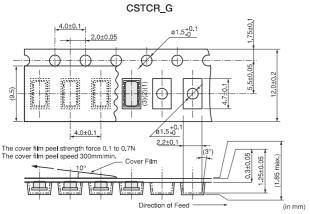


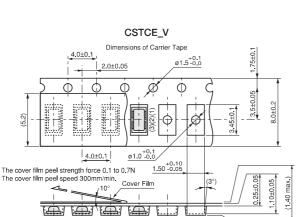


*1, *2: Dimensions vary with product thickness of CERALOCK®.				
Thickness of CERALOCK® 1.40–1.20 1.15–1.00 0.95–0.90				
t1 *1	1.48±0.1	1.30±0.1	1.12±0.1	
t2 *2	2.1 max	1.9 max	1.7 max.	

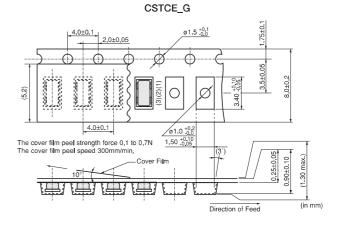


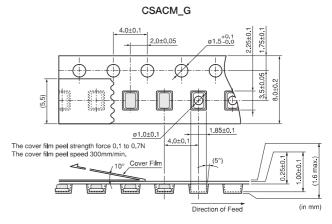
(in mm)





Direction of Feed





Continued on the following page.



(in mm)

(in mm)

(in mm)

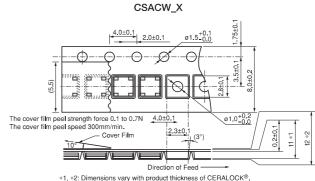
(in mm)

Packaging for Consumer/Industrial Usage -MHz Chip Type-

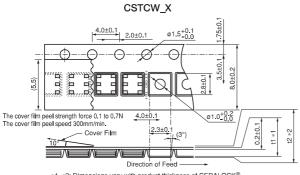
Continued from the preceding page.

■ Dimensions of Taping

CSTCG_V 1.75±0.1 2.0±0.05 ø1.0 +0.1 4.0±0.1 The cover film peel strength force 0.1 to 0.7N The cover film peel speed 300mm/min. 1.50±0. 00±00° (1.30 max.) Cover Film /10° Direction of Feed



*1, *2: E	Dimensions vary v	vith product thic	kness of CERA	ALOCK®.
Thickness of	of CERALOCK®	1.40-1.20	1.15-1.00	0.95-0.90
t1	*1	1.48±0.1	1.30±0.1	1.12±0.1
t2	*2	2.1 max.	1.9 max.	1.7 max.



*1, *2: Dimensions vary with product thickness of CERALOCK®.

Thickness	of CERALOCK®	1.40-1.20	1.15-1.00	0.95-0.90
t1	*1	1.48±0.1	1.30±0.1	1.12±0.1
t2	*2	2.1 max.	1.9 max.	1.7 max.

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Packaging for Consumer/Industrial Usage -MHz Lead Type-

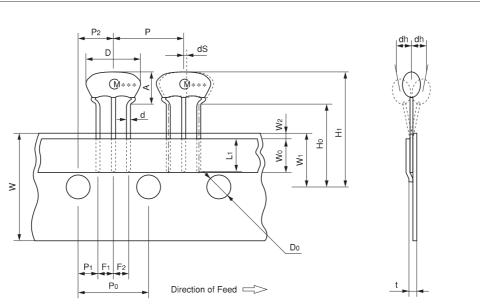
■ Minimum Quantity

Part Number	Ammo Pack	Bulk
CSTLS_G (3.40 to 10.0MHz)	2,000	500
CSTLS_X (16,00 to 70,00MHz)	2,000	500

The order quantity should be an integral multiple of the "Minimum Quantity" shown above.

(pcs.)

■ Tape Dimensions of CSTLS_G



Item	Code	Dimensions	Tolerance	Remarks
Width of diameter	D	8.0	±1.0	
Height of resonator	Α	5.5	±0.5	
Dimensions of terminal	d	ø0.48	±0.05	
Lead length under the hold down tape	L1	5.0 min.	_	
Pitch of component	Р	12.7	±0.5	Tolerance for Pitches 10xPo=127±1
Pitch of sprocket hole	Po	12.7	±0.2	
Length from sprocket hole center to lead	P1	3.85	±0.5	
Length from sprocket hole center to component center	P2	6.35	±0.5	
Lead spacing (I)	F1	2.5	±0.2	
Lead spacing (II)	F2	2.5	±0.2	
Slant forward or backward	dh	0	±1.0	1mm max.
Width of carrier tape	W	18.0	±0.5	
Width of hold down tape	Wo	6.0 min.	-	Hold down tape does not exceed the carrier tape.
Position of sprocket hole	W1	9.0	±0.5	
Gap of hold down tape and carrier tape	W2	0	+0.5 -0	
Distance between the center of sprocket hole and lead stopper	Ho	18.0	±0.5	
Total height of resonator	H1	23.5	±1.0	
Diameter of sprocket hole	Do	ø4.0	±0.2	
Total tape thickness	t	0.6	±0.2	
Body tilt	dS	0	±1.0	

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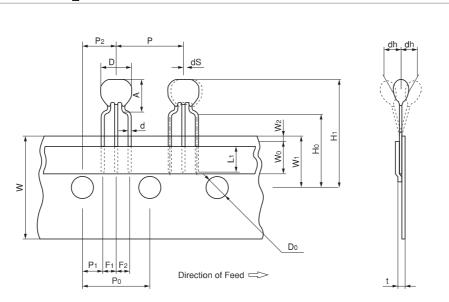
(in mm)



Packaging for Consumer/Industrial Usage -MHz Lead Type-

Ontinued from the preceding page.

■ Tape Dimensions of CSTLS_X



Item	Code	Dimensions	Tolerance	Remarks
Width of diameter	D	5.5	±1.0	
Height of resonator	Α	6.5	±0.5	
Dimensions of terminal	d	ø0.48	±0.05	
Lead length under the hold down tape	L1	5.0 min.	_	
Pitch of component	Р	12.7	±0.5	Tolerance for Pitches 10xP0=127±1
Pitch of sprocket hole	Po	12.7	±0.2	
Length from sprocket hole center to lead	P1	3.85	±0.5	
Length from sprocket hole center to component center	P2	6.35	±0.5	
Lead spacing (I)	F1	2.5	±0.2	
Lead spacing (II)	F2	2.5	±0.2	
Slant forward or backward	dh	0	±1.0	1mm max.
Width of carrier tape	W	18.0	±0.5	
Width of hold down tape	W ₀	6.0 min.	_	Hold down tape does not exceed the carrier tape.
Position of sprocket hole	W ₁	9.0	±0.5	
Gap of hold down tape and carrier tape	W2	0	+0.5 -0.0	
Distance between the center of sprocket hole and lead stopper	Ho	18.0	±0.5	
Total height of resonator	H1	24.5	±1.0	
Diameter of sprocket hole	Do	ø4.0	±0.2	
Total tape thickness	t	0.6	±0.2	
Body tilt	dS	0	±1.0	

(in mm)



Global Locations

For details please visit www.murata.com



⚠Note



For customers outside Japan:

No Murata products should be used or sold, through any channels, for use in the design, development, production, utilization, maintenance or operation of, or otherwise contribution to (1) any weapons (Weapons of Mass Destruction [nuclear, chemical or biological weapons or missiles] or conventional weapons) or (2) goods or systems specially designed or intended for military end-use or utilization by military end-users.

For customers in Japan:

For products which are controlled items subject to the "Foreign Exchange and Foreign Trade Law" of Japan, the export license specified by the law is required for export.

- Please contact our sales representatives or product engineers before using the products in this catalog for the applications listed below, which require especially high reliability for the prevention of defects which might directly damage a third party's life, body or property, or when one of our products is intended for use in applications other than those specified in this catalog.
 - Aircraft equipment
 - Aerospace equipment
 - 3 Undersea equipment
 - Power plant equipment
 - (5) Medical equipment
 - **(6)** Transportation equipment (vehicles, trains, ships, etc.)
 - Traffic signal equipment
 - (3) Disaster prevention / crime prevention equipment
 - Data-processing equipment
 - Application of similar complexity and/or reliability requirements to the applications listed above

- 3 Product specifications in this catalog are as of March 2015. They are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering. If there are any questions, please contact our sales representatives or product engineers.
- 4 Please read rating and \(\Delta\)CAUTION (for storage, operating, rating, soldering, mounting and handling) in this catalog to prevent smoking and/or burning, etc.
- This catalog has only typical specifications.
 Therefore, please approve our product
 specifications or transact the approval sheet
 for product specifications before ordering.
- Please note that unless otherwise specified, we shall assume no responsibility whatsoever for any conflict or dispute that may occur in connection with the effect of our and/or a third party's intellectual property rights and other related rights in consideration of your use of our products and/or information described or contained in our catalogs. In this connection, no representation shall be made to the effect that any third parties are authorized to use the rights mentioned above under licenses without our consent.
- 7 No ozone depleting substances (ODS) under the Montreal Protocol are used in our manufacturing process.



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CSTCC7M37G53-R0 CSTCE8M00G55-R0 CSTCC4M91G53-R0 CSTCR4M19G53-R0 CSTCE10M0G55A-R0 CSTLS3M58G53-B0 CSTCE20M0V53-R0 CSTCV16M0X54J-R0 CSTCV20M0X53J-R0 CSTLS8M00G53-B0 CSTLS8M46G53-B0 CSTLS8M00G53-A0 CSTCE20M0V53A-R0 CSTCE10M0G52-R0 CSTCE16M0V53-R0 CSTCR4M00G53A-R0 CSTLS5M00G53-B0 CSTCR4M19G53A-R0 CSTCC4M00G33A-R0 CSTLS10M0G53-B0 CSTLS6M00G53-B0 CSTLS4M00G53-B0 CSTLS32M0X51-B0 CSTCV20M0X51Q-R0 CSTCE12M0G55A-R0 CSTCR4M91G53-R0 CSTCC8M00G53A-R0 CSTCW24M0X53-R0 CSTLS16M0X55Z-A0 CSTCE10M0G52A-R0 CSTCW27M0X51-R0 CSTCR7M20G53-R0 CSTCR7M37G53-R0 CSTCR7M50G53-R0 CSTCR6M00G55-R0 CSTCR6M00G53-R0 CSTCR4M00G53-R0 CSTCR5M00G53-R0 CSTCE10M0G15A07-R0 CSTCC2M00G53A-R0 CSTLS4M00G53-A0 CSTLS4M91G53-B0 CSTCW40M0X51-R0 CSACW24M0X53-R0 CSTCC10M0G53A-R0 CSTCC2M10G56-R0 CSTCC2M45G53-R0 CSTCC2M45G56-R0 CSTCC3.84MGA-TC CSTCC3M93G53-R0 CSTCC4M91G56A-R0 CSTCC5M00G53-R0 CSTCE10M0G55Z-R0 CSTCE16M0V53ZW-R0 CSTCE20M0V53Z-R0 CSTCE20M0V53ZW-R0 CSTCE8M00G52A-R0 CSTCE8M00G52-R0 CSTCR4M00G53ZW-R0 CSTCR4M00G55A-R0 CSTCR4M91G23-R0 CSTCR6M75G53-R0 CSTCR7M20G53A-R0 CSTCR7M37G53A-R0 CSTCS8.00MT-TC CSTCV14M7X54J-R0 CSTCV19M6X53J-R0 CSTCW70M0X51-R0 CSTLS10M0G53-A0 CSTLS4M08G53-B0 CSTLS4M09G56A-A0 CSTLS8M00G56-B0 CSTCE14M7V53-R0 CSTCE9M83G52-R0 CSTCV24M0X53J-R0 CSTCE11M0G15002-R0 CSTCR7M99G53-R0 CSACV16M0X55J-R0 CSTCE14M3V53-R0 CSTCE14M7V53W-R0 CSTCC8M00G56-R0 CSTCC9M00G53-R0 CSTCE12M0G55W-R0 CSTCE20M0V51-R0 CSTCG20M0V51-R0 CSTCG20M0V51W-R0 CSTLS3M58G56-B0 CSTCE1630V53-R0 CSTLS3M58G53-A0 CSTLS4M00G56-A0 CSTLS4M91G56-B0 CSTCC2M40G53Z-R0 CSTLS7M68G53-A0 CSTCR5M00G55-R0 CSTCS14.32MX040-TC CSTLS8M00G53Z-B0 CSTLS16M0X55-B0 CSTCC10M0G53-R0 CSTCE20M0V53C-R0 CSTCG27M0V53-R0